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March 2009

FAIROHILD

FAN7085_F085 High Side Gate Driver with Recharge FET

Features

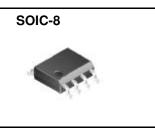
- Qualified to AEC Q100
- Floating channel designed for bootstrap operation fully operational up to 300V.
- Tolerance to negative transient voltageon VS pin
- dv/dt immune.
- Gate drive supply range from 4.5V to 20V
- Under-voltage lockout
- · CMOS Schmitt-triggered inputs with pull-down and pull-up
- · High side output out of phase with input (Inverted input)
- Reset input
- Internal recharge FET for bootstrap refresh

Typical Applications

- · Diesel and gasoline injectors/valves
- · MOSFET-and IGBT high side driver applications

Description

The FAN7085_F085 is a high-side gate drive IC with reset input and built-in recharge FET. It is designed for high voltage and high speed driving of MOSFET or IGBT, which operates up to 300V. Fairchild's high-voltage process and common-mode noise cancellation technique provide stable operation in the high side driver under high-dV/dt noise circumstances. Logic input is compatible with standard CMOS outputs. The UVLO circuits prevent from malfunction when VCC and VBS are lower than the specified threshold voltage. It is available with space saving SOIC-8 Package. Minimum source and sink current capability of output driver is 250mA and 250mA. Built-in recharge FET to refresh bootstrap circuit is very useful for circuit topology requiring switches on low and high side of load.

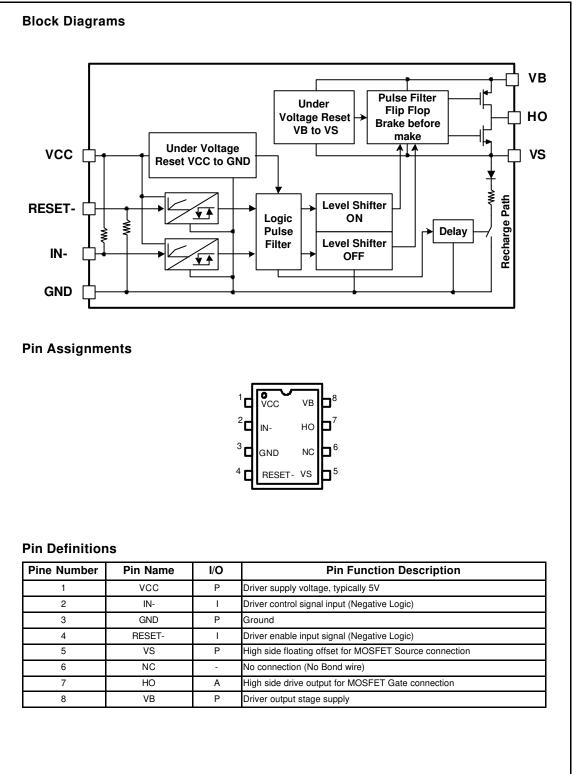


Ordering Information

Device	Package	Operating Temp.
FAN7085CM	SOIC-8	-40 °C ~ 125 °C
FAN7085CMX	SOIC-8	-40 °C ~ 125 °C
V . Tana & Baal tuna		

X : Tape & Reel type

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Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to GND.

Parameter	Symbol	Min.	Max.	Unit
High side floating supply voltage	VBS	-0.3	25	V
High side driver output stage voltage Neg. transient: 0.5 ms, external MOSFET off	Vв	-5	325	V
High side floating supply offset voltage Neg. transient 0.2 us	Vs	-25	300	V
High side floating output voltage	Vно	VS-0.3	VB+0.3	V
Supply voltage	Vcc	-0.3	25	V
Input voltage for IN-	VIN	-0.3	Vcc+0.3	V
Input voltage for RESET-	VRES	-0.3	Vcc+0.3	V
Power Dissipation 1)	Pd		0.625	W
Thermal resistance, junction to ambient ¹⁾	Rthja		200	°C/W
Electrostatic discharge voltage (Human Body Model)	V _{ESD}	1.5K		V
Charge device model	V _{CDM}	500		V
Junction Temperature	Tj		150	C°
Storage Temperature	Τ _s	-55	150	C°

Note: 1) The thermal resistance and power dissipation rating are measured bellow conditions;

JESD51-2: Integrated Circuit Thermal Test Method Environmental Conditions - Natural condition(StillAir)

JESD51-3: Low Effective Thermal Conductivity Test Board for Leaded Surface Mount Package

Recommended Operating Conditions

For proper operation the device should be used within the recommended conditions.-40°C <= Ta <= 125°C

Parameter	Symbol	Min.	Max.	Unit
High side floating supply voltage(DC) Transient:-10V@ 0.2 us	VB	VS+4.5	VS+20	V
High side floating supply offset voltage(DC) @VBS=7V	Vs	-3	300	V
High side floating supply offset voltage(Transient) 0.2us @VBS<25V	Vs	-25	300	V
High side floating output voltage	Vно	Vs	VB	V
Allowable offset voltage Slew Rate ¹⁾	dv/dt	-	50	V/ns
Supply voltage for logic part	Vcc	4.5	20	V
Input voltage for IN-	VIN	0	Vcc	V
Input voltage for RESET-	VRESET	0	Vcc	V
Switching frequency ²⁾	Fs		200K	Hz
Minimum low input width ³⁾	UN(Low,min)	1000	-	ns
Minimum high input width 3)	tin(high,min)	60	-	ns
Minimum operating voltage of VB related to GND	VB(MIN) ⁴⁾	4	-	V
Ambient temperature	Ta	-40	125	°C

Note: 1) Guaranteed by design.

2) Duty = 0.5, VBS >=7V

3) Guaranteed by design. Pulse widths below the specified values, may be ignored. Output will either follow the inputsignal or will ignore it. No false output state is guaranteed when minimum input width is smaller than tin 4) Guaranteed by design

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
VCC and VBS Supply Characteristics						
Vcc and VBS supply under voltage positive going threshold	Vccuv+ Vbsuv+	VCC and VBS rising from 0V	-	3.7	4.3	V
Vcc and VBs supply under voltage negative going threshold	Vccuv- Vbsuv-	Vcc and Ves dropping from 5V	2.8	3.4	-	V
Vcc and VBS under voltage hysteresis	Vccuvh Vbsuvh	-	0.02	0.3	-	V
Under voltage lockout response time	tduvcc tduvbs	VCC: 6.5V->2.4V or 2.4V->6.5V VBS: 6.5V->2.4V or 2.4V->6.5V	0.5 0.5		20 20	us us
Offset supply leakage current	Ilκ	VB=VS=300V	-	-	200	uA
Quiescent Vcc supply current	lacc	Vcc=20V	-	-	500	uA
Quiescent VBS supply current	IQBS1	Static mode, VBS=7V, VIN=0 or 5V			100	uA
Quiescent VBS supply current	IQBS2	Static mode, VBS=16V, VIN=0 or 5V			200	uA
VBS drop due to output turn-on (Design guaranty)	ΔVBS	VBS=7V, Cbs=1uF, tdig-in=3uS, ttest=100uS			210	mV
Input Characteristics						
High logic level input voltage for IN-	Vін		0.6Vcc	-	-	V
Low logic level input voltage for IN-	VIL		-	-	0.28Vcc	V
Low logic level input bias current for IN-	lin-	VIN=0	5	25	60	uA
High logic level input bias current for IN-	lin+	VIN=5V	-	-	5	uA
Full up resistance at IN	Rin		83	200	1000	KΩ
High logic level input voltage for RESET-	Vrh		0.6Vcc	-	-	V
Low logic level input voltage for RESET-	Vrl				0.28Vcc	V
High logic level input current for RESET-	IRES+	Vreset=5V	5	25	60	uA
Low logic level input bias current for RESET-	IRES-	Vreset=0			5	uA
Full down resistance at RESET-	Rres		83	200	1000	KΩ
Output characteristics						
High level output voltage, VB - VHO	Vон	lo=0	-	-	0.1	V
Low level output voltage, VHO-GND	Vol	lo=0	-	-	0.1	V
Peak output source current	lo +	VIN=5V	250	450	-	mA
Peak output sink current	lo-	Vin=0	250	450	-	mA
Equivalent output resistance	Rop			15.5	28	Ω
	Ron			15.5	28	Ω
Recharge Characteristics		•				1
Recharge TR turn-on propagation delay	Ton_rech		4	7.9	9.8	us
Recharge TR turn-off propagation delay	Toff_rech			0.2	0.4	us
Recharge TR on-state voltage drop	VRECH	ls=1mA, VIN=5V @125°C			1.2	V
Dead Time Characteristics		-				
High side turn-off to recharge gate turn-on	Dthoff	Vcc=5V, Vs=7V	4	7.8	9.8	us
Recharge gate turn-off to high side turn-on	DTHON	Vcc=5V, Vs=7V	0.1	0.4	0.7	us

Note: The input parameter are referenced to GND. The VO and IO parameters are referenced to GND.

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Dynamic Electrical Characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input-to-output turn-on propagation delay	tplh	50% input level to 10% output level, $Vs = 0V$		0.56	1	us
Input-to-output turn-off propagation delay	tphi	50% input level to 90% output level Vs = 0V	-	0.15	0.5	us
RESET-to-output turn-off propagation delay	tphl_res	50% input level to 90% output level	-	0.17	0.5	us
RESET-to-output turn-on propagation delay	tplh_res	50% input level to 10% output level	-	0.56	1	us
Output rising time	tr1	Tj=25°C	-	65	200	ns
	tr2			-	400	ns
	tr3	Tj=25°C, Vas=16V		65	200	ns
	tr4	V _{BS} =16V		-	400	ns
Output falling time	tf1	Tj=25°C	-	25	200	ns
	tf2			-	300	ns
	tf3	Tj=25°C, Vas=16V		25	200	ns
	tf4	V _{BS} =16V	1	-	300	ns

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Application Information

1. Logic Tables

VCC	VBS	RESET-	IN-	Но	RechFET
< VCCUVLO-	Х	Х	Х	OFF	ON
Х	Х	LOW	Х	OFF	ON
Х	Х	Х	HIGH	OFF	ON
> VCCUVLO+	> VBSUVLO+	HIGH	LOW	ON	OFF
> VCCUVLO+	< VBSUVLO-	HIGH	LOW	OFF	OFF

Notes:

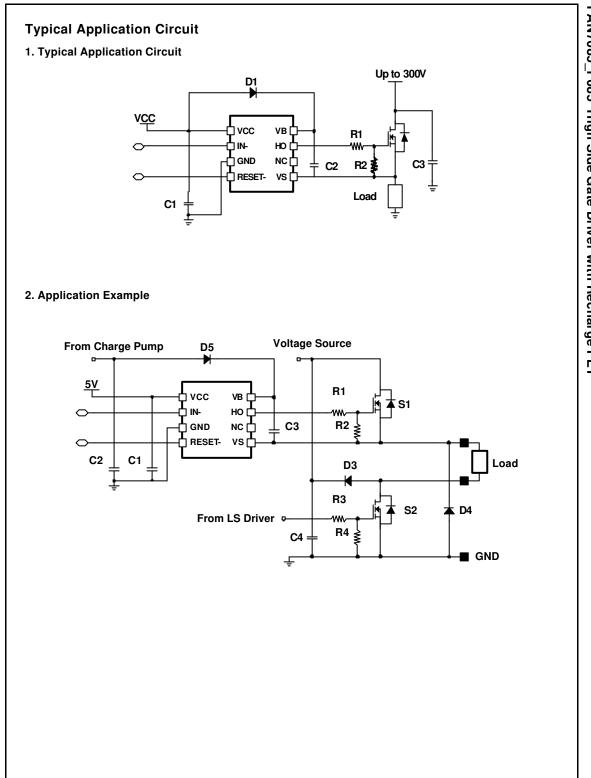
X means independent from signal

IN-=LOW indicates that the high side NMOS is ON

IN-=HIGH indicates that the high side NMOS is OFF RechFET =ON indicates that the recharge MOSFET is ON

RechFET =OFF indicates that the recharge MOSFET is OFF

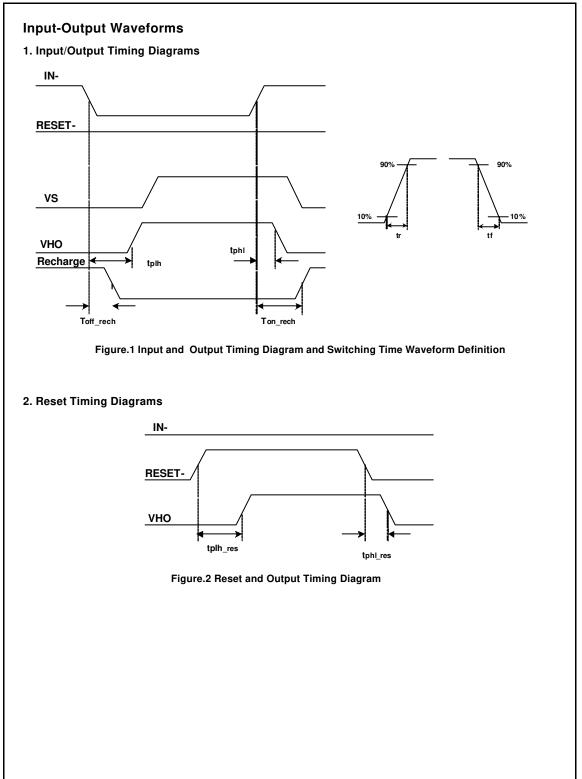
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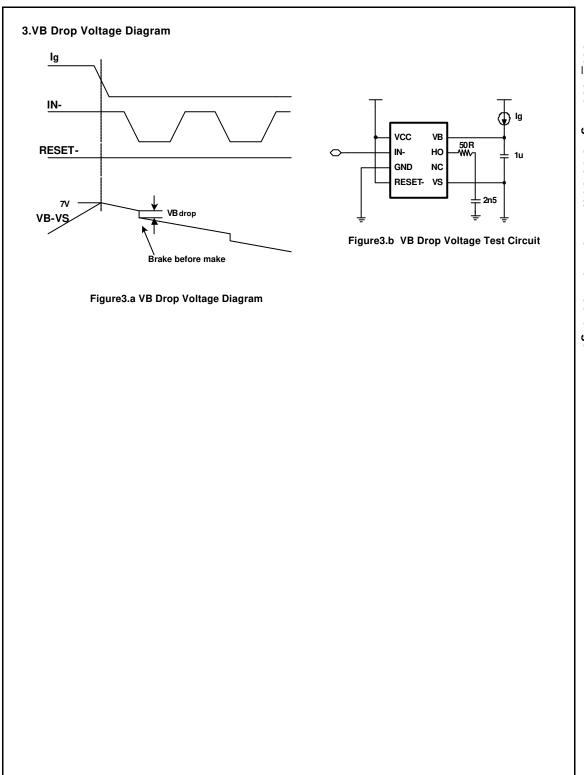


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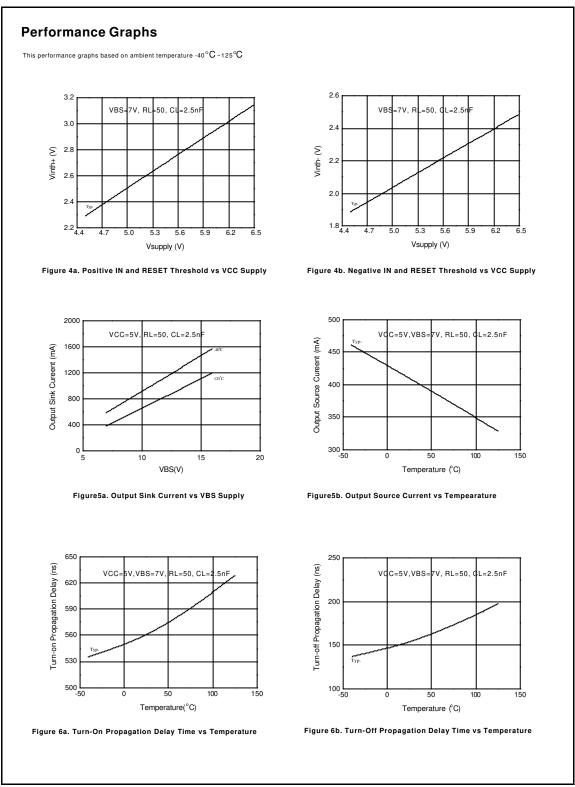
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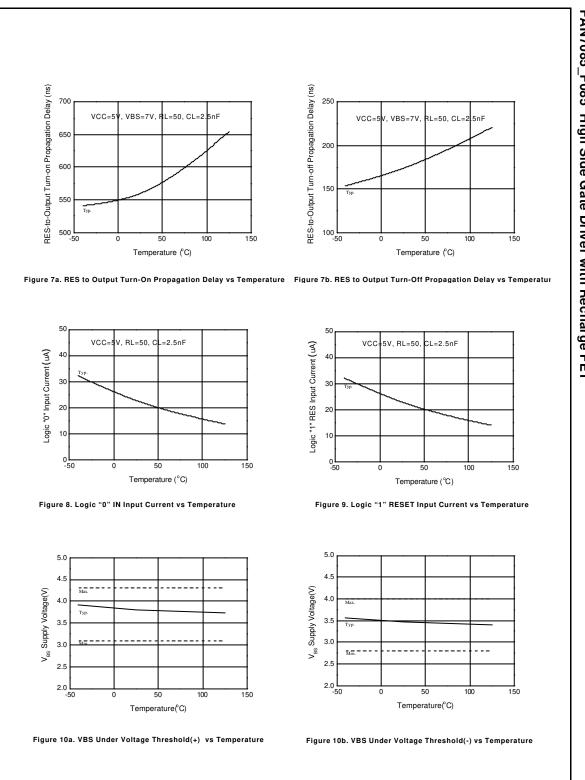
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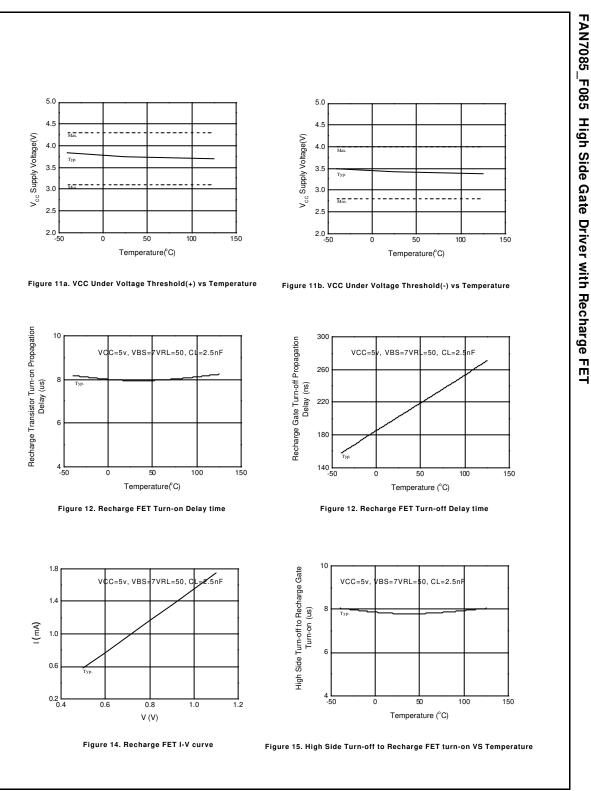
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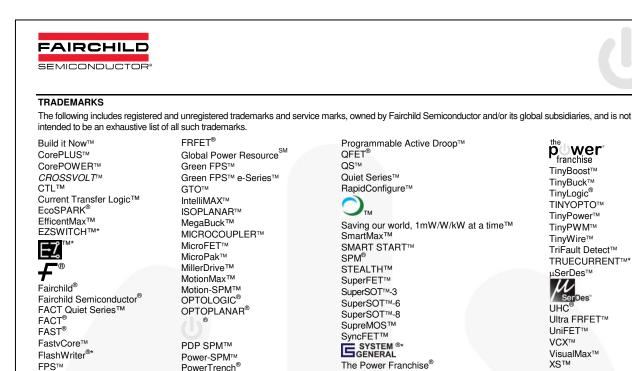
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Package Dimensions 8-SOP Inches Millimeters Notes Symbol Min. Max. Min. Max. .053 .069 1.35 1.75 A A1 .004 .010 0.10 0.25 В .013 .020 0.33 0.51 C D E .0075 010 0.20 0.25 189 4.80 5.00 .197 150 158 3.81 4.01 e H .050 BSC 1.27 BSC 6.20 .244 5.79 228 h .010 .020 0.25 0.50 L .016 .050 0.40 1.27 З N 6 0 8 0 8 u CCC .004 0.10 8 Notes: A 1. Dimensioning and tolerancing per ANSI Y14.5M-1982. 2 "D" and "E" do not include mold flash. Mold flash or protrusions shall not exceed .010 inch (0.25mm). E 3. "L" is the length of terminal for soldering to a substrate. 4. Terminal numbers are shown for reference only. Ħ Ħ 5. "C" dimension does not include solder finish thickness. 4 6. Symbol 'N' is the maximum number of terminals. D h x 45 SEATING - C -PLANE LEAD COPLANARITY C ccc C В

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